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To the Honorable Commissioner of Patents and Trademarks. Please reco	ord the attached original documents or copy thereof.			
1. Name of Conveying Party(ies): Kazumasa YANAGISAWA, Toshio SASAKI, Satoru NAKANISHI and Yoshihiko YASU Additional names of conveying parties attached 3. Nature of Conveyance: Security Agreement Security Agreement Change of Name Other: Execution Date: February 23, 2001	2. Name and Address of Receiving Party(ies): Name: (1) Hitachi Ltd. (2) Hitachi ULSI Systems Co., Ltd. Internal Address: Street Address: (1) 6, Kanda Surugadai 4-chome (2) 22-1, Josuihoncho 5-chome City, State, Zip: (1) Chiyoda-ku, Tokyo, Japan (2) Kodaira-shi, Tokyo, Japan			
4. (a) Patent Application Number(s): If this document is being filed together with a new application, the execution date of the application is: February 23, 2001	4. (b) Patent Numbers: 09820972			
☐ Additional Numbers Attached.				
5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:	6. Total Number of Applications and Patents Involved: 1			
Name: Stanley P. Fisher	7. Total Fee: \$40.00 (37 C.F.R. § 3.41)			
Address: Reed Smith Hazel Thomas LLP 3110 Fairview Park Dr. Suite 1400 Falls Church, Va. 22042	 ≅ Enclosed. □ Authorized to be charged to deposit account. 8. Deposit Account Number: 			
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9. Statement and Signature: To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document. March 30, 2001				
Startley P. Fisher, Registration No. 24,344 / Total number of pages comprising cover sheet: Total number of pages comprising cover sheet:				
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ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD. and Hitachi ULSI Systems Co., Ltd., corporations organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, and 22-1, Josuihoncho 5-chome, Kodaira-shi, Tokyo, Japan, respectively, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD. and Hitachi ULSI Systems Co., Ltd., their successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire owner ship of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD. and Hitachi ULSI Systems Co., Ltd., their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD. and Hitachi ULSI Systems Co., Ltd.

Signed on the date(s) indicated aside signatures:

INVENTOR(S) (発明者フルネームサイン)

RECORDED: 03/30/2001

Date Signed (署名日)

1)	(Gzymasa Yanggisawa	(Kazumasa Yanagisawa)	23/February /2001
2)	Toshio Sasaki	(Toshio SASAKI)	, n ,
3)	Satorn Nakanishi	(Satoru NAKANISHI)	23/February /200/
4)	Yoshihiko Yasu	(Yoshihiko YASU)	23/February/2001
5)			
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PATENT REEL: 011671 FRAME: 0905